

# SPECIFICATION FOR LCD MODULE MODULE NO: YB-TG176220S12A-N-B0

Doc.Version:01

Customer Approval:	
□ Accept	Reject

YEEBO	NAME	SIGNATURE	DATE
Prepare	Electronic Engineer	stat's	>15-9.4
Check	Mechanical Engineer	Vor 2	2015.9.4
Verify		65 4 12	7015.9.4
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APPROVAL FOR SPECIFICATIONS ONLY

□ APPROVAL FOR SPECIFICATIONS AND SAMPLE

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## **<u>1. Revision History</u>**

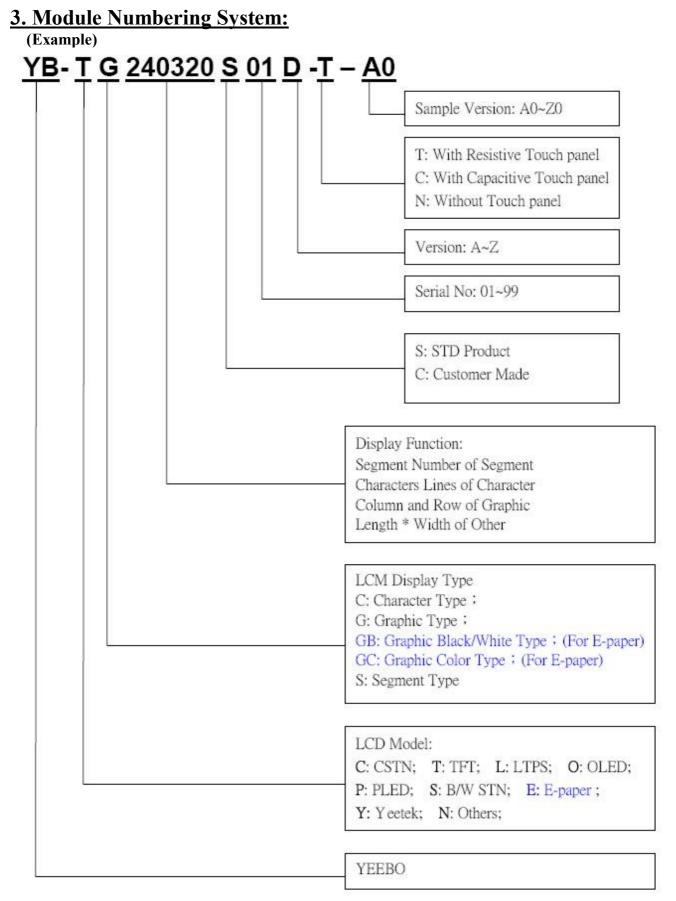
Sample Version	DOC. Version	DATE		DESCRIPTION		
B0	00	2014-02-18	SPEC ONLY	First issue	Wes/Calamie	
В0	01	2015-09-04	SPEC ONLY	Modify Table of Contents(P.2) General Specification(P.4) LCM drawing(P.5) Viewing Angle(P.12) Backlight (P.16) Defect out of viewing area can be neglected (P.21) Definition of Pixel(P.26)	Shien/CFJ	



## **<u>2. Table of Contents:</u>**

NO	CONTENTS	PAGE
1	Revision History	1
2	Table of Contents	2
3	Module Numbering System	3
4	General Specification	4
5	LCM drawing	5
6	Electrical Characteristics	6
7	Optical Characteristics	11
8	Interface Pin Assignment	13
9	Block Diagram	15
10	Backlight	16
11	Standard Specification for Reliability	17
12	Specification of Quality Assurance	19
13	Handing Precaution	28
14	Guarantee	28





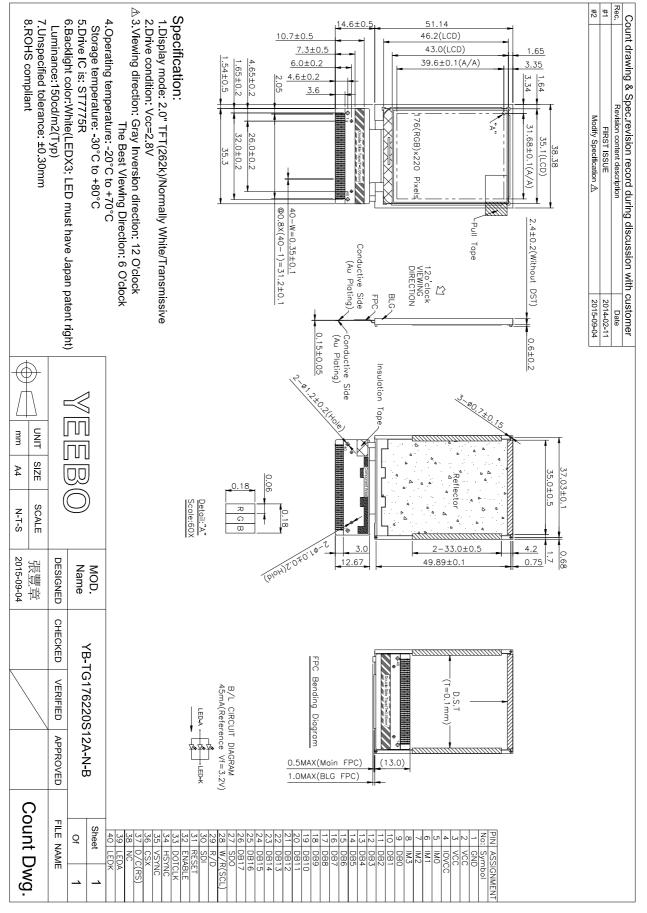


## 4. General Specification:

ITEM	CONTENTS				
Module Size	38.38 (W) * 51.14 (H) * 2.4 (T) mm				
Module Size(With FPC)	38.38 (W) * 65.74 (H) * 2.4 (T) mm				
Display Size (Diagonal)	2.0 inch				
Display Format	176(RGB)* 220 Pixels				
Active Area	31.68 (W) * 39.6 (H) mm				
Dots Pitch	0.18 * 0.18 mm				
LCD Type	TFT (262K)/ Transmissive / Normal White				
Viewing Direction (Gray Inversion)	12:00 O'clock				
The Best Viewing Direction:	6:00 O'clock				
Controller IC	ST7775R				
Weight	6.9g				



## 5. LCM drawing:



Module P/N: YB-TG176220S12A-N-B0 Doc.Version:00



## **<u>6. Electrical Characteristics</u>**

## 6-1 Absolute Maximum Ratings

(Ta=25°C VSS=0V)

Item	Symbol	Min.	Туре	Max.	Unit	Remark
Power Supply voltage	VCC	-0.3		+4.6	Volt	
rower suppry vortage	IOVCC	-0.3	-	+4.6	Volt	
Operating Temperature	Topr	-20	-	+70	°C	
Storage Temperature	Tstg	-30	-	+80	°C	

Note: Absolute maximum rating is the limit value beyond which the IC maybe broken.

#### **6-2 Operating Conditions**

(Ta=25°C)

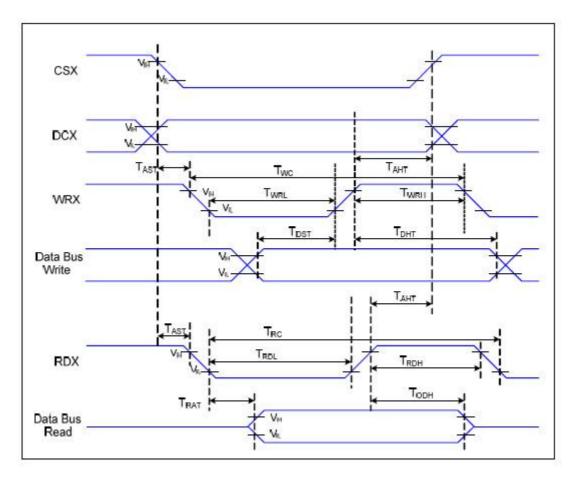
v 2 operating co	(14	<b>2</b> 3 (C)				
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply voltage	VCC	-	2.6	2.8	3.0	Volt
i ower supply voltage	IOVCC		2.6	2.8	3.0	Volt
	VIH	-	0.8*IOVCC	-	IOVCC	Volt
Level Input Voltage	VIL	-	GND	I	0.2*IOVCC	Volt
Level Input Voltage	VOH	-	0.8*IOVCC	I	IOVCC	Volt
	VOL	-	GND	-	0.2*IOVCC	Volt
Power Supply Current for LCM	ICC	VCC=2.8V	-	3.8	5.8	mA

Note:GND=0V

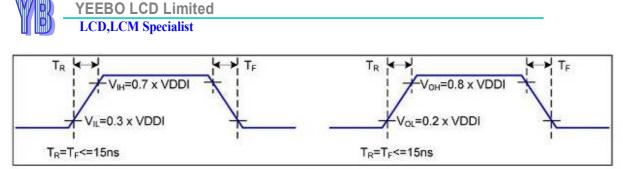


#### 6-3 Timing Characteristics( Reference to IC: ST7775R )

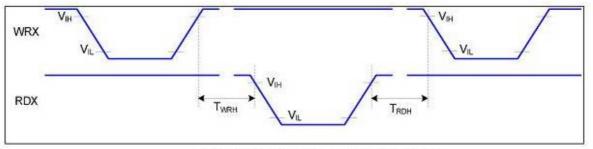
8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus



Signal	Symbol	Parameter	Min	Max	Unit	Description
DOX	TAST	Address Setup Time	10	320	ns	
DCX	TAHT	Address Hold Time (Write/Read)	5	-	ns	
	TWC	Write Cycle	70	328	ns	
WRX	TWRH	Control Pulse "H" Duration	35	3 <b>-</b> 3	ns	
	TWRL	Control Pulse "L" Duration	35		ns	
	TRC	Read Cycle (ID)	300	120	ns	
RDX	TRDH	Control Pulse "H" Duration (ID)	150		ns	When Read ID Data
	TRDL	Control Pulse "L" Duration (ID)	150	828	ns	
	TDST	Data Setup Time	10		ns	TRAT, TRATFM: 3K
DB[17:0]	TDHT	Data Hold Time	15		ns	ohm Pull up or Dowr and 30pF Parallel
	TRAT	Read Access Time (ID)	2	100	ns	Cap. To GND.
	TODH	Output Disable Time	50	121	ns	TODH: 3K ohm Pull up or Down.



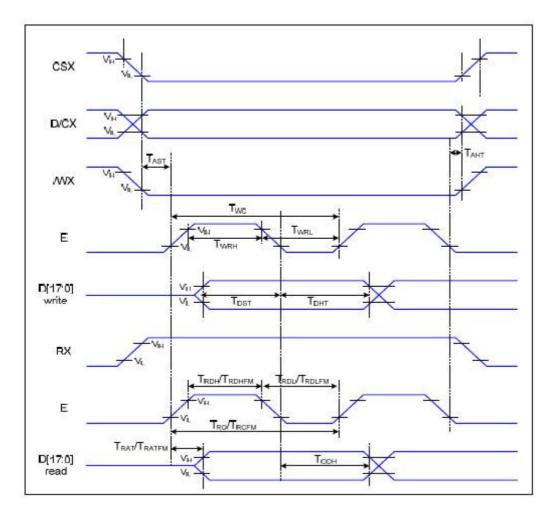
Rising and Falling Timing for I/O Signal



Write-to-Read and Read-to-Write Timing

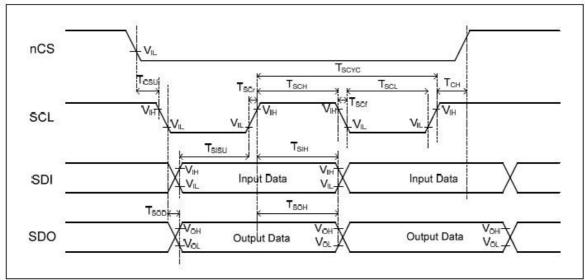
Note: The rising time and falling time (Tr, Tf) of input signal and fall time are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

#### 6800 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus



Signal	Symbol	Parameter	Min	Max	Unit	Description
DCX	T <sub>AST</sub>	Address setup time	10		ns	
DUX	T <sub>AHT</sub>	Address hold time (Write/Read)	5		ns	
	Twc	Write cycle	70		ns	
E	T <sub>WRH</sub>	Control pulse "H" duration	35		ns	]
	T <sub>WBL</sub>	Control pulse "L" duration	35		ns	
	T <sub>RC</sub>	Read cycle (ID)	300		ns	
RDX (ID)	T <sub>RDH</sub>	Control pulse "H" duration (ID)	150		ns	When read ID data
	T <sub>RDL</sub>	Control pulse "L" duration (ID)	150		ns	
DB[17:0]	TDST	Data setup time	10		ns	For maximum
	Трнт	Data hold time	15		ns	CL=30pF
	Торн	Output disable time	50		ns	For minimum CL=8pF

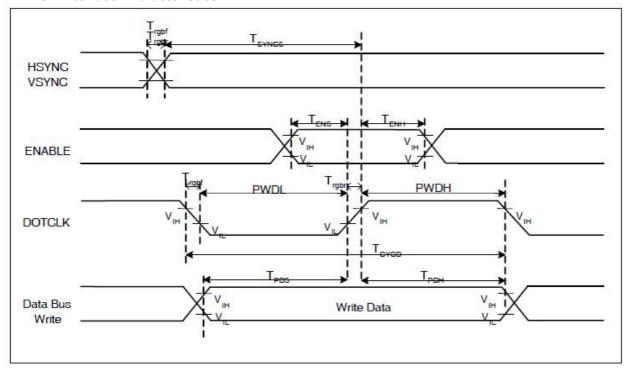
#### Serial Data Transfer Interface Characteristics



Signal	Symbol	Parameter	Min	Max	Unit	Description
001	TCSU	Chip Select Setup Time	10		ns	
CSX	TCH	Chip Select Hold Time	50		ns	-
	TSCr ,TSCf	Serial clock rise/fall time		5	ns	
	TSCH	SCL "H" pulse width (Write)	40		ns	
	TSCH	SCL "H" pulse width (Read)	100		ns	
SCL	TSCYC	Serial clock cycle (Write)	80		ns	
	TSCYC	Serial clock cycle (Read)	200		ns	
	TSCL	SCL "L" pulse width (Write)	40		ns	
	TSCL	SCL "L" pulse width (Read)	100		ns	
001	TSISU	Serial Input Data Setup Time	20		ns	
SDI	TSIH	Serial Input Data Hold Time	20		ns	
200	TSOD	Serial Output Data Setup Time		100	ns	5
SDO	TSOH	Serial Output Data Hold Time	5		ns	



#### **RGB Interface Characteristics**



Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC,	TSYNCS	VSYNC, HSYNC Setup Time	0		ns	
VSYNC	Trghr, Trghf	VSYNC, HSYNC Rise/Fall time		25	ns	
EN LOUIE	TENS	Enable Setup Time	10		ns	
ENABLE	TENH	Enable Hold Time	10		ns	
	PWDH	DOTCLK High-level Pulse Width	40		ns	
DOTOLK	PWDL	DOTCLK Low-level Pulse Width	40		ns	
DOTCLK	TCYCD	DOTCLK Cycle Time	100		ns	
	Trghr, Trghf	DOTCLK Rise/Fall time		25	ns	
DB	TPDS	PD Data Setup Time	10		ns	2
	TPDH	PD Data Hold Time	40		ns	

18/16 Bits RGB Interface Timing Characteristics

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC,	TSYNCS	VSYNC, HSYNC Setup Time	0		ns	
VSYNC	Trghr, Trghf	VSYNC, HSYNC Rise/Fall time		25	ns	
ENABLE	TENS	Enable Setup Time	10		ns	
CINADLE	TENH	Enable Hold Time	10		ns	
	PWDH	DOTCLK High-level Pulse Width	30		ns	
DOTCLK	PWDL	DOTCLK Low-level Pulse Width	30		ns	
DUTCLK	TCYCD	DOTCLK Cycle Time	80		ns	
	Trghr, Trghf	DOTCLK Rise/Fall time		25	ns	
DB	TPDS	PD Data Setup Time	10		ns	
	TPDH	PD Data Hold Time	30		ns	

6 Bits RGB Interface Timing Characteristics



## 7. Optical Characteristics:

Itar	_	Symbol	Canditions	Spe	cificatio	ons	Unit	Nata
Iten	Item		Conditions	Min	Тур	Max	Unit	Note
Transmit	ttance	T(%)	-	-	5.0	-	-	-
Contrast Ratio		CR	θ=0 Normal Viewing angle	250	500	-		(1)(2)
Response	e time	TR+TF	-	-	10	20	ms	(1)(3)
	Hor.	Θx+		-	70	-		(4)
Viewing	пот.	Θx-	$CR \ge 10$	-	70	-	deg.	
angle	Ver.	Θy+		-	70	-		
	vel.	Θy-		-	60	-		

Measuring Condition

1. Measuring surrounding: dark room

2. Ambient temperature:  $25\pm2^{\circ}C$ 

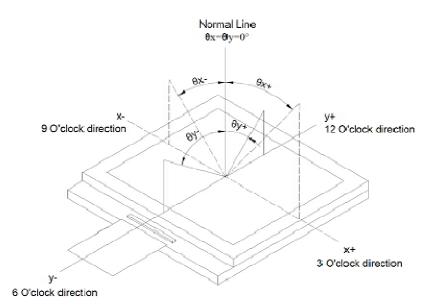
3. 30 min. Warm-up time.

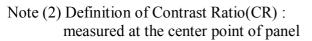
#### Color of CIE Coordinate:

Item		Symbol	Condition	Min.	Тур.	Max.	Brightness
	D 1	х		0.5907	0.5930	0.5997	40 1/ 2
	Red	У	$0 - a - 0^{\circ}$	0.3437	0.3452	0.3479	40 cd/m <sup>2</sup>
	G	х	$\theta = \varphi = 0^{\circ}$ LED Backlight	0.3157	0.3171	0.3181	210 cd/m <sup>2</sup>
Chromaticity	Green	у	Color Degree X=0.30	0.5875	0.5883	0.5892	210 cu/iii
Coordinates (Transmissive)	Blue	X	Y=0.30	0.1485	0.1486	0.1489	55 1/ 2
(Transmissive)		У	Brightness = $4300 \text{ cd/m}^2$	0.0765	0.0777	0.0795	55 cd/m <sup>2</sup>
	White	X	4500 <b>Cu</b> /III	0.2732	0.2776	0.2811	200 1/ 2
		у		0.2949	0.2983	0.3027	300 cd/m <sup>2</sup>



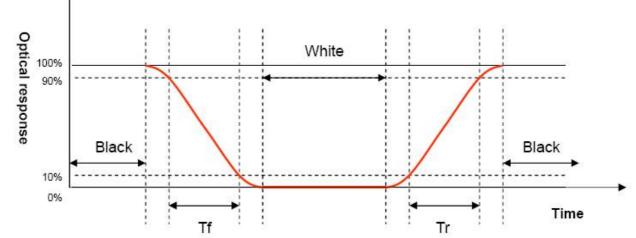
#### Note (1) Definition of Viewing Angle :





Contrast ratio (CR)= Photo detector output when LCD is at "White" state Photo detector output when LCD is at "Black

Note (3) Definition of Response Time : Sum of TR and TF



Note (4) Suggestion: LCD at the optima view direction is"12 O'clock ". When at the large angle, it is possible to see the grayscale inversion, for the reason that the best view direction by the human eye is"6 O'clock ".



## **8. Interface Pin Assignment:**

## 8-1 LCM FPC Interface

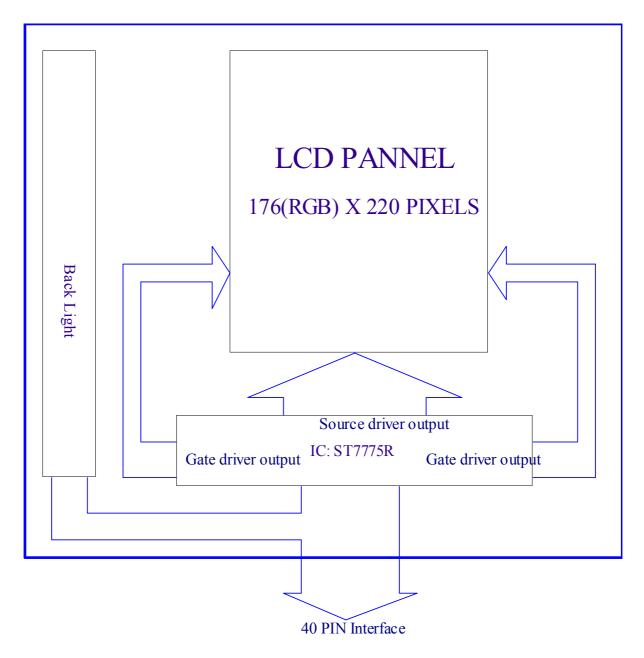
No.	Symbol	Funct	tion							
1	GND	Pow	Power Ground							
2	VCC	Powe	Power Supply for Analog, Digital System and Booster Circuit.							
3	VCC		Power Supply for Analog, Digital System and Booster Circuit.							
4	IOVCC	Powe	Power Supply for I/O System.							
		IM3	IM2	IM1	IMO	MCU Interface Mode	Data pin			
		0	0	0	0	68-16 bit	DB[17:10], DB[8:1]			
		0	0	0	1	68-8 bit	DB[17:10]			
		0	0	1	0	80-16 bit	DB[17:10], DB[8:1]			
		0	0	1	1	80-8 bit	DB[17:10],			
		0	1	0	ID	24-bit SPI	CSX ,SCL ,SDI, SDO			
5~8	IM0~IM3	0	1	1	0	9- bit SPI	CSX,SCL,SDA			
		0	1	1	1	8- bit SPI	CSX,SCL,SDA,DCX			
		1	0	0	0	68-18 bit	DB[17:0]			
		1	0	0	1	68-9 bit	DB[17:9]			
		1	0	1	0	80-18bit	DB[17:0]			
		1	0	1	1	80-9bit	DB[17:9]			
		1	1	- 122	222	Setting invalid				
		MCU	bara	llel ir	nterfa	ce data bus -If not i	used, please fix this pin at G	ND		
9~26	DB0~DB17	level.	1			•••••••••••••••••••••••••••••••••••••••				
		SPI interface output pin.								
27	SDO	The data is outputted on the falling edge of the SCL signal.								
						this pin at floating.				
28	W/R(SCL)					J parallel interface. used as SCL.				
						MCU parallel interf	ace			
29	R/D					this pin at VCC or				
		SPI in		· •		<u>.</u>				
		The data is latched on the rising edge of the SCL signal.								
30	SDI	In the 24-bit serial peripheral interface, this pin is used as input Pin.								
	~	In the 8/9-bit serial peripheral interface, this pin is used as bi-directional								
		data p		nlar	so fir	this pin at GND le	vol			
							ust be applied to properly			
31	RESET						ast of applied to property			
			initialize the chip. Low active Data enable signal for RGB interface operation.							
32	ENABLE						select (access disabled)			
						this pin at VCC or				
33	DOTCLK					RGB interface opera				
				_		this pin at GND le		-4:-		
34	HSYNC						gnal for RGB interface operation	ation.		
		If not used, please fix this pin at GND level.								



35	VSYNC	Vertical (Frame) synchronizing input signal for RGB interface operation. If not used, please fix this pin at GND level.
36	CSX	Chip selection pin.
37	D/C(RS)	Display data/command selection pin in MCU interface. D/C='1': display data or parameter. D/C='0': command data. If not used, please fix this pin at VCC or GND level.
38	NC	No Connect.
39	LEDA	LED Light, anode
40	LEDK	LED Light, cathode



## 9. Block Diagram:





## 10. Backlight:

- 1. Standard Lamp Styles (Edge Lighting Type): The LED chips are distributed over the edge light area of the illumination unit, which gives the less power consumption:
- 2. The Main Advantages of the LED Backlight are as following:
  - 2.1 The brightness of the backlight can simply be adjusted. By a resistor or a potentiometer.

5. Data About LED Backligh	m.						
PARAMETER	Sym.	Min.	Тур.	Max.	Unit	Test Condition	Note
Supply Voltage	V	2.9	3.2	3.5	V	If=45mA	
Reverse Voltage	VR	-	-	5	V	-	
Luminous Intensity for LCM	Iv	100	150	-	Cd/m <sup>2</sup>		2
Uniformity for LCM	-	70	-	-	%	If=45mA	3
Life Time	-	20000	50000	-	Hr.		4
Color		White					

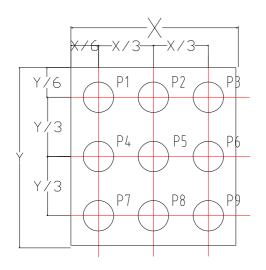
3. Data About LED Backlight:

NOTE:

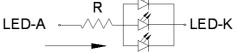
- 1. Backlight Only
- 2. Average Luminous Intensity of P1-P9
- 3. Uniformity = Min/Max \* 100%
- 4. LED life time defined as follow: the final brightness is at 50% of original brightness

Measured Method: (X\*Y: Light Area)

#### Internal Circuit Diagram









## **<u>11. Standard Specification for Reliability:</u>**

#### 11 - 1 Standard Specifications for Reliability of LCD Module

No	Item	Description
01	High temperature operation	The sample should be allowed to stand at $70^{\circ}$ C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation	The sample should be allowed to stand at $-20^{\circ}$ C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage	The sample should be allowed to stand at $80^{\circ}$ C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.
04	Low temperature storage	The sample should be allowed to stand at $-30^{\circ}$ C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage	The sample should be allowed to stand at $60^{\circ}$ C,90%RH MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles : -30°C for 30 minutes $\rightarrow$ normal temperature for 5 minutes $\rightarrow$ +80°C for 30 minutes $\rightarrow$ normal temperature for 5 minutes, as one cycle.
07	Packing vibration	Frequency range : 10Hz ~ 55Hz Amplitude of vibration : 1.5mm X,Y,Z 2 hours for each direction.
08	Packing drop test	According to ISTA 1A 2001.



09	Electrical Static	Air: ±4KV 150pF/330Ω 5 times
*0	Discharge	Contact: $\pm 2$ KV 150pF/330 $\Omega$ 5 time

\*Sample size for each test item is 3~5pcs

#### 11 - 2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 11-1, Standard specifications for Reliability have been executed in order to ensure stability.

No	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

#### 11- 3. MTBF

MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ( $25\pm5^{\circ}$ C), normal humidity ( $50\pm10\%$ RH), and in area not exposed to direct sun light.
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## **<u>12. Specification of Quality Assurance:</u>**

12-1. Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by YEEBO CORPORATION (Supplier).

12-2. Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

- c. Test of Appearance Characteristics:
  - According to the individual specification to test the product.
- d. Test of Reliability Characteristics: According to the definition of reliability on the specification for testing products.
- e. Delivery Test:

Before delivering, the supplier should take the delivery test.

(i) Test method: According to MIL-STD105E.General Inspection Level II take a single time.

(ii) The defects classify of AQL as following:

Major defect: AQL = 0.65

- Minor defect: AQL = 2.5
- Total defects: AQL = 2.5
- 12-3. Non- conforming Analysis & Deal With Manners
  - a. Non- conforming Analysis:
  - (i) Purchaser should supply the detail data of non- conforming sample and the non-conforming.
  - (ii) After accepting the detail data from purchaser, the analysis of non- conforming should be finished in two weeks.
  - (iii) If supplier can not finish analysis on time, must announce purchaser before 3 days.
  - b. Disposition of non- conforming:
    - (i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.
    - (ii) Both supplier and customer should analyze the reason and discuss the disposition of non- conforming when the reason of nonconforming is not sure.

#### 12-4. Agreement items

Both sides should discuss together when the following problems happen.

- a. There is any problem of standard of quality assurance, and both sides should think that must be modified.
- b. There is any argument item which does not record in the standard of quality assurance.
- c. Any other special problem.

12-5. Standard of The Product Appearance Test

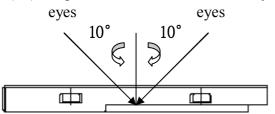
a. Manner of appearance test:

(i) The test must be under 20W  $\times$  2 or 40W fluorescent light, and the distance of view must be at 30±5cm.

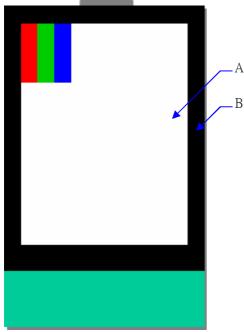
(ii) When test the model of transmissive product must add the reflective plate.

(iii)The test direction is base on around 10° of vertical line.

(iiii)Temperature: 25±5°C Humidity: 60±10%RH



(iv) Definition of area:



- A. Area: Viewing area.
- B. Area: Out of viewing area.

(Outside viewing area)

- b. Basic principle:
- (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (iii) Must add new item on time when it is necessary.
- c. Standard of inspection: (Unit: mm)



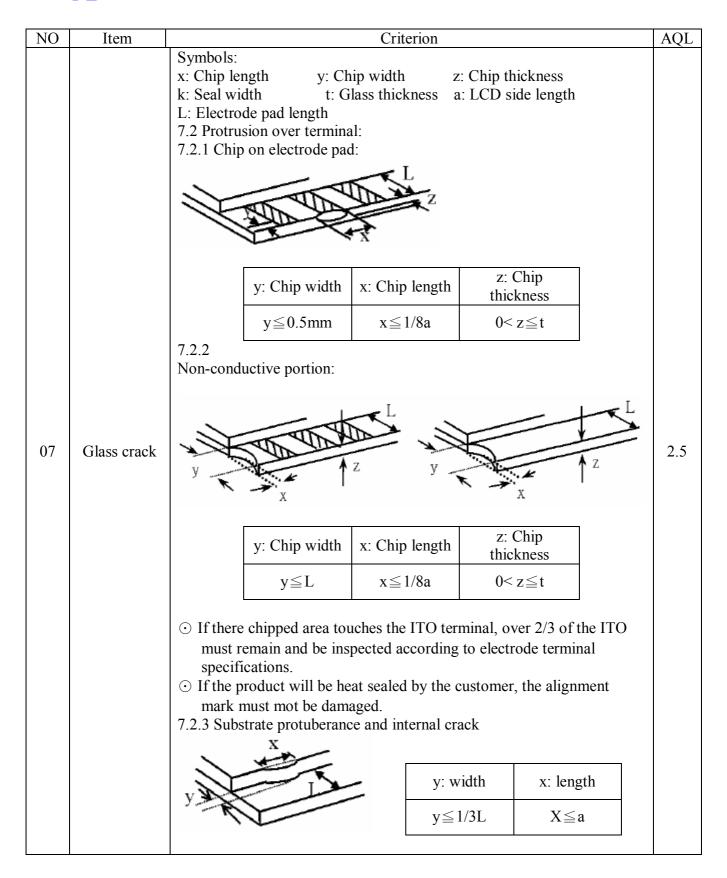
12-6. Inspection specification Defect out of viewing area can be neglected.

NO	Item	i viewing area can be ne	0	riterion		AQL
01	Electrical Testing	<ol> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Flicker</li> </ol>				
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	<ul> <li>2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots.</li> <li>2.2 Densely spaced: No more than three spots within 3mm.</li> </ul>				
02	LCD and Touch Panel black spots,		ely spaced	Size(mm) $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi \le 0.30$ $0.30 < \Phi$ : No more than two	Acceptable Q'ty Accept no dense 2 2 1 0 o spots within 3mm.	2.5
03	white spots, contamination (non – display)	3.2 Line type: (As follo $\downarrow$ $\underline{W}$ $\downarrow$ $\underline{W}$ $L$ $\underline{W}$ * Dens	Length( mm)  L≦3.0 L≦2.5 	Width(mm) $W \le 0.02$ $0.02 < W \le 0.05$ $0.03 < W \le 0.08$ $0.08 < W$	Accept no dense	2.5



NO	Item	Criterion				
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in 	2.5			
05	Scratches	Follow NO.3 -2 Line Type.				
06	Chipped glass	Symbols: x: Chip length t: Glass thickness a: LCD side length 	2.5			

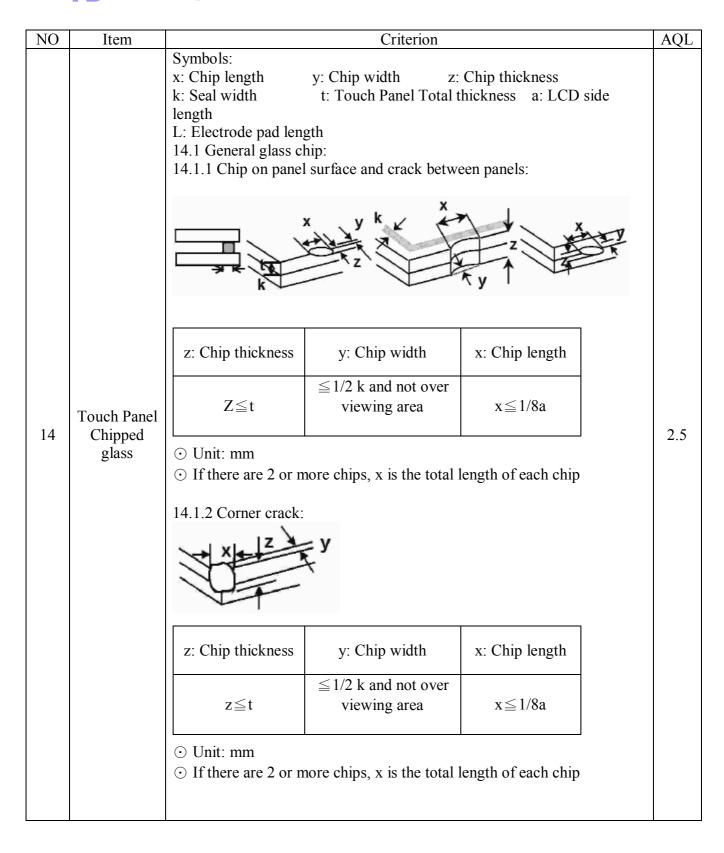






NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	<ul> <li>9.1 Illumination source flickers when lit.</li> <li>9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>9.3 Backlight doesn't light or color is wrong.</li> </ul>	2.5 2.5 0.65
10	Bezel	Bezel must comply with product specifications.	2.5
11	РСВ、СОВ	<ul> <li>11.1COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>11.2 COB seal surface may not have pinholes through to the IC.</li> <li>11.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places.</li> <li>11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts.</li> <li>11.6 The jumper on the PCB should conform to the product characteristic chart.</li> </ul>	2.5 2.5 2.5 2.5 0.65 0.65
12	FPC	<ul> <li>12.1 FPC terminal damage ≤ 1/2 FPC terminal width and can not affect the function, we judge accept.</li> <li>12.2 FPC alignment hole damage ≤ 1/2 alignment area and can not affect the function, we judge accept.</li> </ul>	2.5 2.5
13	Soldering	<ul><li>13.1 No cold solder joints, missing solder connections, oxidation or icicle.</li><li>13.2 No short circuits in components on PCB or FPC.</li></ul>	2.5 0.65







NO	Item	Criterion		
15	Touch Panel(Fish eye、dent and bubble on film)	SIZE(mm)Acceptable Q'ty $\Phi \le 0.2$ Accept no dense $0.2 < D \le 0.4$ 5 $0.4 < D \le 0.5$ 2 $0.5 < D$ 0	2.5	
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion( $\leq 2.5\%$ ), it is acceptable.		
17	Touch Panel Linearity	Less than 2.5% is acceptable.		
18	LCD Ripple	Touch the touch panel, can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g		
19	General appearance	<ul> <li>19.1 Pin type must match type in specification sheet.</li> <li>19.2 LCD pin loose or missing pins.</li> <li>19.3 Product packaging must the same as specified on packaging specification sheet.</li> <li>19.4 Product dimension and structure must conform to product specification sheet.</li> </ul>		
20	Definition of Pixel	Pixel : Group of Three Sub-pixels ( Red, Green ,Blue):		



Dark Dot Defects				
Dots( sub-pixels) on display which is dark in the picture and visible at				
Red/Green/Black/White Pattern.				
Neighbour Dot Defects				
Two or three neighbour dots ( dot: sub-pixel) cluster( R&G,G&B,B&R,or				
R&G&B).Dot Defects Inspection Criteria				
NOTE : Dot out of VA can be ignored.				
Items Inspection Criteria				
	Details	Allowed quantity		
Bright Dot	Not Neighbour Dot	2		
Dark Dot	Not Neighbour Dot	3		
Total acceptable Qty		5		
• Size of dot defect is a	larger than half of one sub	-pixel.		



## **<u>13. Handling Precaution:</u>**

13-1 Handling of LCM

- Don't give external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance. Must not lick and swallow. when the liquid is attach to your hand, skin, cloth etc. Wash it out thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

#### 13-2 Storage

- Store in an ambient temperature of 25±10°C, and in a relative humidity of 50±10%RH. Don't expose to sunlight or fluorescent light.
- Storage in a clean environment, free from dust, active gas, and solvent.
- Store in anti-static electricity container.
- Store without any physical load.

#### 13-3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: No higher than  $280\pm10^{\circ}$ C and less than 3 sec during Hand soldering.
- Rewiring: no more than 2 times.

#### 14. Guarantee:

Our products could meet requirements of the environment.

YB's RoHS is introduce European Union Directive 2011/65/EU (ROHS) Requirements and update.